O-RAN TIFG December 2019 Plugfest Call for Participation

The O-RAN Alliance is preparing for an O-RAN Plugfest in December which aims to accelerate the maturity of O-RAN products/solutions via conducting the conformance and interoperability tests. With this email, we are kindly inviting you to join this event.

There will be two parallel PlugFest sessions.

1) The Beijing Session will be hosted by China Mobile at Beijing from December 2th to December 17th. There will be two focuses with one on open front-haul interface with conformance of definition in WG4, and the other on SW/HW decoupling with conformance of AAL SDK API defined in WG6/WG8.

2) The parallel session will be in conjunction with the OSC POC event that makes use of the global open labs structure with a focus on the Open Fronthaul interface with conformance from the definition in WG4 as well as supporting the OSC efforts with WG1 OA&M and Use Cases.

Logistics:

Venue 1: CMCC International Information Data Center, Dongtuo town, 310 Manbai Road, Changping District, Beijing.
Date: December 2nd to 17th, 2019
Agenda:
Dec. 2nd to Dec. 13th: test activity
Dec. 16th to Dec 17th: Plugfest seminar to share test results and experience.

Venue 2: Multiple Labs connected to the global OSC Open labs
Date: December xx to xx, 2019 (**More details to come**)

Call for Participation:

If your company is interested to participate in this Plugfest related to the test activity and/or the seminar, please contact the following with the necessary details. Additionally, if you have interest to include a particular lab to be inclusive of the global OSC labs, please include that information.

Beijing Plugfest: Yanmin@chinamobile.com

Global OSC Labs Plugfest: david.orloff@att.com

Thank you,
TIFG co-chairs